



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:
Wu, et al.

Serial No. 10/753253

Filed: January 8, 2004

For: RAPID TEMPERATURE
COMPENSATION MODULE FOR
SEMICONDUCTOR TOOL

§ Attorney Docket No. 24061.81
§
§ Customer No. 27683
§
§ Group Art Unit: Unknown
§
§ Examiner: Unknown
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LETTER TO THE OFFICIAL DRAFTSPERSON

Attn: Official Draftsperson
Commissioner For Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Sir:

Enclosed are two (2) sheets of formal drawings to replace the informal drawings as originally filed in the above-identified patent application.

Respectfully submitted,

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Date: 2-6-04
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R-66536

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